

Configured Digital Potentiometer (DP): Programmable Voltage Applications

**HALOGEN FREE
LEAD FREE**

FEATURES

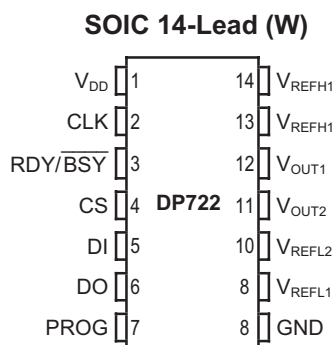
- Two 8-bit DPs configured as programmable voltage sources in DAC-like applications
- Independent reference inputs
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 2 independently addressable buffered output wipers
- 1 LSB accuracy, high resolution
- Serial Microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

For Ordering Information details, see page 13.

APPLICATIONS

- Automated product calibration.
- Remote control adjustment of equipment
- Offset, gain and zero adjustments in self-calibrating and adaptive control systems.
- Tamper-proof calibrations.
- DAC (with memory) substitute.

PIN CONFIGURATION



DESCRIPTION

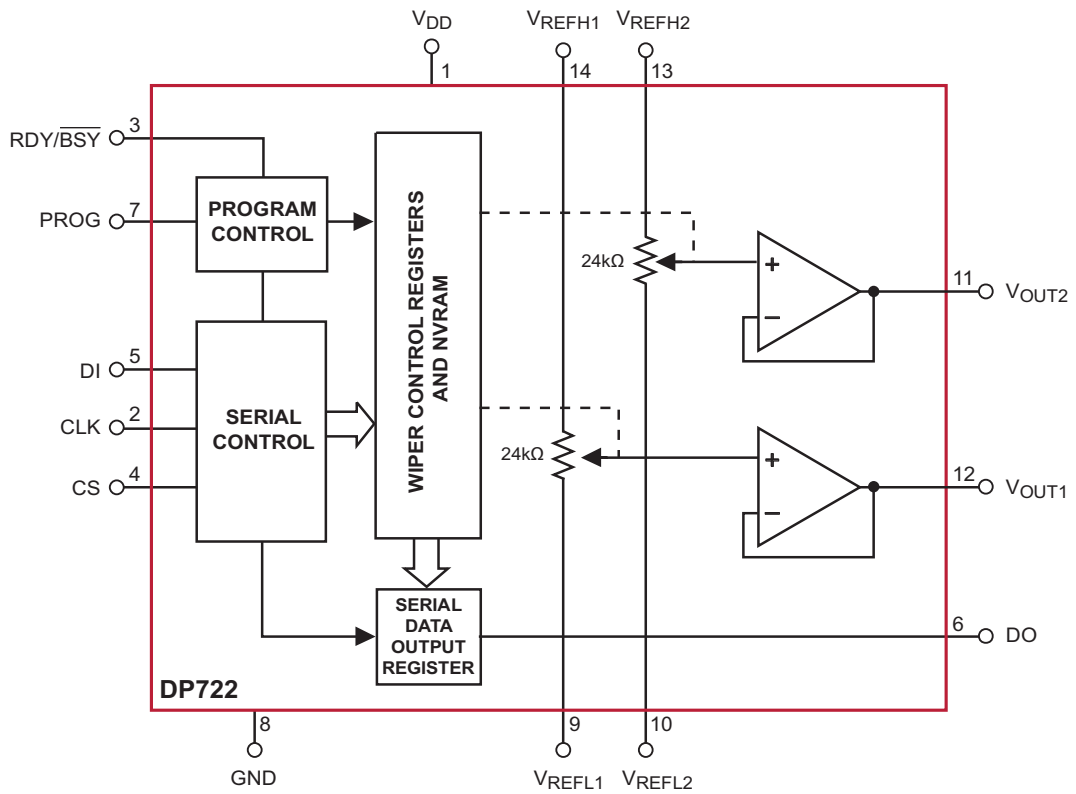
The DP722 is a dual, 8-bit digital potentiometer (DP) configured for programmable voltage and DAC-like applications. Intended for final calibration of products such as camcorders, fax machines and cellular telephones on automated high volume production lines, it is also well suited for self-calibrating systems and for applications where equipment which requires periodic adjustment is either difficult to access or in a hazardous environment.

The DP722 offers two independently programmable DPs each having its own reference inputs and each capable of rail to rail output swing. The wipers are buffered by rail to rail opamps. Wiper settings, stored in non-volatile NVRAM memory, are not lost when the device is powered down and are automatically reinstated when power is returned. Each wiper can be dithered to test new output values without effecting the stored settings and stored settings can be read back without disturbing the DP's output.

The DP722 is controlled with a simple 3-wire, microwire-like serial interface. A Chip Select pin allows several devices to share a common serial interface. Communication back to the host controller is via a single serial data line thanks to the DP722 Tri-Stated Data Output pin. A RDY/ $\overline{\text{BSY}}$ output working in concert with an internal low voltage detector signals proper operation of the non-volatile NVRAM memory Erase/Write cycle.

The DP722 is available in the -40°C to 85°C industrial operating temperature ranges. 14-pin surface mount packages are available.

FUNCTIONAL DIAGRAM



ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Parameters	Ratings	Units
Supply Voltage V _{DD} to GND	-0.5 to +7	V
Inputs		
CLK to GND	-0.5 to V _{DD} +0.5	V
CS to GND	-0.5 to V _{DD} +0.5	V
DI to GND	-0.5 to V _{DD} +0.5	V
RDY/BSY to GND	-0.5 to V _{DD} +0.5	V
PROG to GND	-0.5 to V _{DD} +0.5	V
V _{REFH} to GND	-0.5 to V _{DD} +0.5	V
V _{REFL} to GND	-0.5 to V _{DD} +0.5	V

Parameters	Ratings	Units
Outputs		
D ₀ to GND	-0.5 to V _{DD} +0.5	V
V _{OUT} 1– 4 to GND	-0.5 to V _{DD} +0.5	V
Operating Ambient Temperature Industrial ('I' suffix)	-40 to +85	°C
Junction Temperature	+150	°C
Storage Temperature	-65 to +150	°C
Lead Soldering (10s max)	+300	°C

RELIABILITY CHARACTERISTICS

Symbol	Parameter	Test Method	Min	Max	Units
V _{ZAP} ⁽²⁾	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000		V
I _{LTH} ⁽²⁾⁽³⁾	Latch-Up	JEDEC Standard 17	100		mA

POWER SUPPLY

Symbol	Parameter	Conditions	Min	Typ	Max	Units
I _{DD1}	Supply Current (Read)	Normal Operating	—	400	600	μA
I _{DD2}	Supply Current (Write)	Programming, V _{DD} = 5V	—	1600	2500	μA
		V _{DD} = 3V	—	1000	1600	μA
V _{DD}	Operating Voltage Range		2.7	—	5.5	V

LOGIC INPUTS

Symbol	Parameter	Conditions	Min	Typ	Max	Units
I _{IH}	Input Leakage Current	V _{IN} = V _{DD}	—	—	10	μA
I _{IL}	Input Leakage Current	V _{IN} = 0V	—	—	-10	μA
V _{IH}	High Level Input Voltage		2	—	V _{DD}	V
V _{IL}	Low Level Input Voltage		0	—	0.8	V

LOGIC OUTPUTS

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V _{OH}	High Level Output Voltage	I _{OH} = -40μA	V _{DD} -0.3	—	—	V
V _{IL}	Low Level Output Voltage	I _{OL} = 1mA, V _{DD} = +5V	—	—	0.4	V
		I _{OL} = 0.4mA, V _{DD} = +3V	—	—	0.4	V

Notes:

- (1) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions outside of those listed in the operational sections of this specification is not implied. Exposure to any absolute maximum rating for extended periods may affect device performance and reliability.
- (2) This parameter is tested initially and after a design or process change that affects the parameter.
- (3) Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to V_{CC} + 1V.

POTENTIOMETER CHARACTERISTICS

$V_{DD} = +2.7V$ to $+5.5V$, $V_{REFH} = V_{DD}$, $V_{REFL} = 0V$, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R _{POT}	Potentiometer Resistance			24		kΩ
	R _{POT} to RPOT Match		—	±0.5	±1	%
	Pot Resistance Tolerance				±20	%
	Voltage on V _{REFH} pin		2.7		V _{DD}	V
	Voltage on V _{REFL} pin		0		V _{DD} - 2.7	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
R _{OUT}	Buffer Output Resistance				10	Ω
I _{OUT}	Buffer Output Current				3	mA
TC _{RPOT}	TC of Pot Resistance			300		ppm/°C
C _H /C _L	Potentiometer Capacitances			8/8		pF

AC ELECTRICAL CHARACTERISTICS

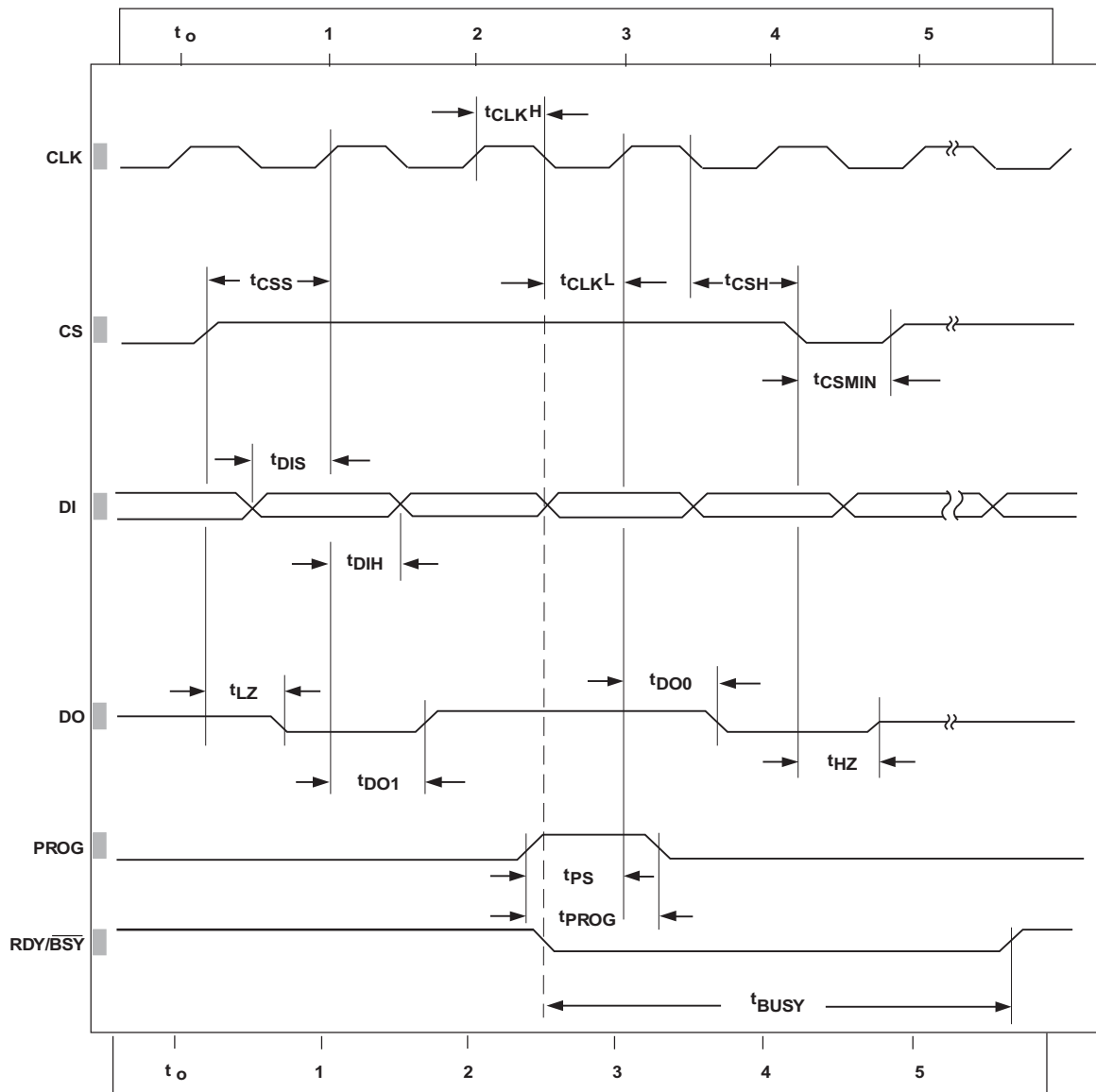
$V_{DD} = +2.7V$ to $+5.5V$, $V_{REFH} = V_{DD}$, $V_{REFL} = 0V$, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Digital						
t _{CSMIN}	Minimum CS Low Time		150	—	—	ns
t _{CSS}	CS Setup Time		100	—	—	ns
t _{CSH}	CS Hold Time	C _L = 100pF ⁽¹⁾	0	—	—	ns
t _{DIS}	DI Setup Time		50	—	—	ns
t _{DIH}	DI Hold Time		50	—	—	ns
t _{DO1}	Output Delay to 1		—	—	150	ns
t _{DO0}	Output Delay to 0		—	—	150	ns
t _{HZ}	Output Delay to High-Z		—	400	—	ns
t _{LZ}	Output Delay to Low-Z	—	400	—	ns	
t _{BUSY}	Erase/Write Cycle Time		—	4	5	ms
t _{PS}	PROG Setup Time		150	—	—	ns
t _{PROG}	Minimum Pulse Width		700	—	—	ns
t _{CLKH}	Minimum CLK High Time		500	—	—	ns
t _{CLKL}	Minimum CLK Low Time		300	—	—	ns
f _C	Clock Frequency		DC	—	1	MHz
Analog						
t _{DS}	DP Settling Time to 1 LSB	C _{LOAD} = 10pF, V _{DD} = +5V	—	3	10	μs
		C _{LOAD} = 10pF, V _{DD} = +3V	—	6	10	μs

Notes:

- (1) All timing measurements are defined at the point of signal crossing $V_{DD} / 2$.
- (2) These parameters are periodically sampled and are not 100% tested.

A.C. TIMING DIAGRAM



PIN DESCRIPTION

Pin	Name	Function
1	V _{DD}	Power supply positive
2	CLK	Clock input pin
3	RDY/ $\overline{\text{BSY}}$	Ready/Busy output
4	CS	Chip select
5	DI	Serial data input pin
6	DO	Serial data output pin
7	PROG	EEPROM Programming Enable Input
8	GND	Power supply ground
9	V _{REFL1}	Minimum DP1 output voltage
10	V _{REFL2}	Minimum DP2 output voltage
11	V _{OUT2}	DP2 output
12	V _{OUT1}	DP1 output
13	V _{REFH2}	Maximum DP2 output voltage
14	V _{REFH1}	Maximum DP1 output voltage

DEVICE OPERATION

The DP722 is a dual 8-bit configured digital potentiometer (DP) whose outputs can be programmed to any one of 256 individual voltage steps. Once programmed, these output settings are retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPs return to the settings stored in non-volatile memory. Each DP can be written to and read from independently without effecting the output voltage during the read or write cycle. Each output can also be adjusted without altering the stored output setting, which is useful for testing new output settings before storing them in memory.

DIGITAL INTERFACE

The DP722 employs a 3 wire serial, Microwire-like control interface consisting of Clock (CLK), Chip Select (CS) and Data In (DI) inputs. For all operations, address and data are shifted in LSB first. In addition, all digital data must be preceded by a logic "1" as a start bit. The DP address and data are clocked into the DI pin on the clock's rising edge. When sending multiple blocks of information a minimum of two clock cycles is required between the last block sent and the next start bit.

DP addressing is as follows:

DP OUTPUT	A0	A1
V _{OUT1}	0	1
V _{OUT2}	1	1

Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-Stated and returns to a high impedance when not in use.

CHIP SELECT

Chip Select (CS) enables and disables the DP722's read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DP control registers will remain in effect until CS goes low. Bringing CS to a logic low returns all DP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been desensitized with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

CLOCK

The DP722's clock controls both data flow in and out of the IC and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being

saved may already be resident in the DP wiper control register.

No clock is necessary upon system power-up. The DP722's internal power-on reset circuitry loads data from non-volatile memory to the DPs without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control registers. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

V_{REF}

V_{REF}, the voltage applied between pins V_{REFH} & V_{REFL}, sets the DP's Zero to Full Scale output range where V_{REFL} = Zero and V_{REFH} = Full Scale. V_{REF} can span the full power supply range or just a fraction of it. In typical applications V_{REFH} & V_{REFL} are connected across the power supply rails. When using less than the full supply voltage be mindfull of the limits placed on V_{REFH} and V_{REFL} as specified in the References section of DC Electrical Characteristics.

READY/BSY

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the DP721 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V_{DD}. If V_{DD} is below the

minimum value required for non-volatile programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

DATA OUTPUT

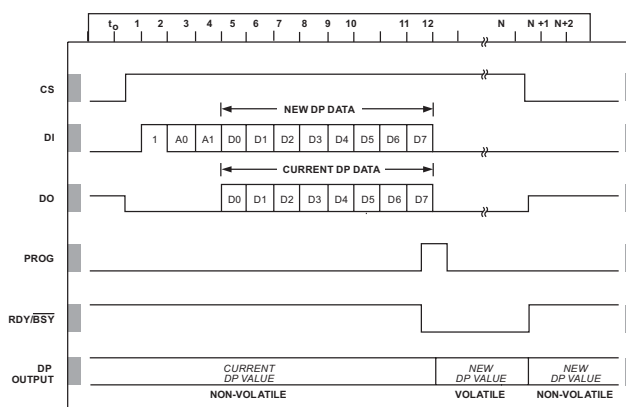
Data is output serially by the DP722, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 722s to share a single serial data line and simplifies interfacing multiple 722s to a microprocessor.

WRITING TO MEMORY

Programming the DP722's non-volatile memory is accomplished through the control signals: Chip Select (CS) and Program (PROG). With CS high, a start bit followed by a two bit DP address and eight data bits are clocked into the DP wiper control register via the DI pin. Data enters on the clock's rising edge. The DP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is accomplished by bringing PROG high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DP wiper control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of generating and ramping up the programming voltage for data transfer to the non-volatile cells. The DP722's non-volatile memory cells will endure over 1,000,000 write cycles and will retain data for a minimum of 100 years without being refreshed.

Figure 1. Writing to Memory



READING DATA

Each time data is transferred into a DP control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DP's output. This feature allows μ Ps to poll DPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13th clock cycle completes. In doing so the non-volatile memory setting is reloaded into the DP wiper control register. Since this value is the same as that which had been there previously no change in the DP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then *a change would occur* at the read cycle's conclusion.

TEMPORARILY CHANGE OUTPUT

The DP722 allows temporary changes in DP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

Figure 3 shows the control and data signals needed to effect a temporary output change. DP wiper settings may be changed as many times as required and can be made to any of the two DPs in any order or sequence. The temporary setting(s) remain in effect long as CS remains high. When CS returns low all two DPs will return to the output values stored in non-volatile memory.

When it is desired to save a new setting acquired using this feature, the new value must be reloaded into the DP wiper control register prior to programming. This is because the DP722's internal control circuitry discards from the programming register the new data two clock cycles after receiving it if no PROG signal is received.

Figure 2. Reading from Memory

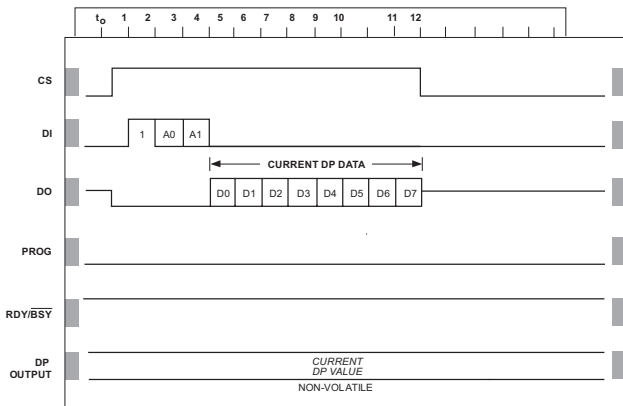
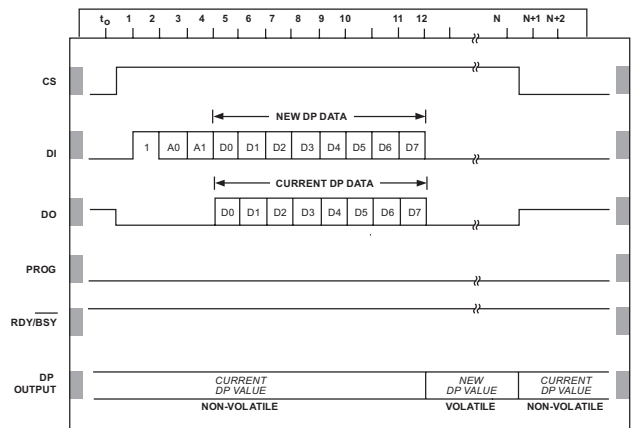
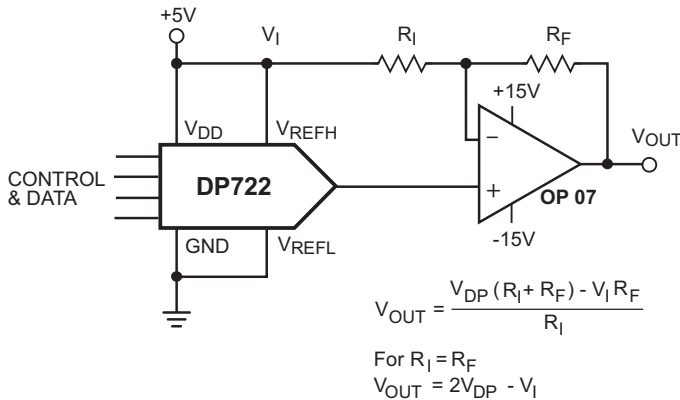


Figure 3. Temporary Change in Output

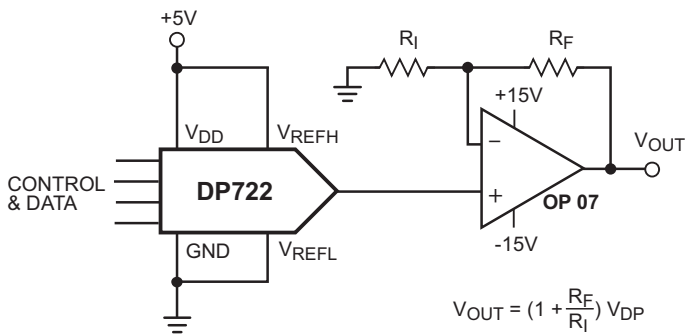


APPLICATION CIRCUITS

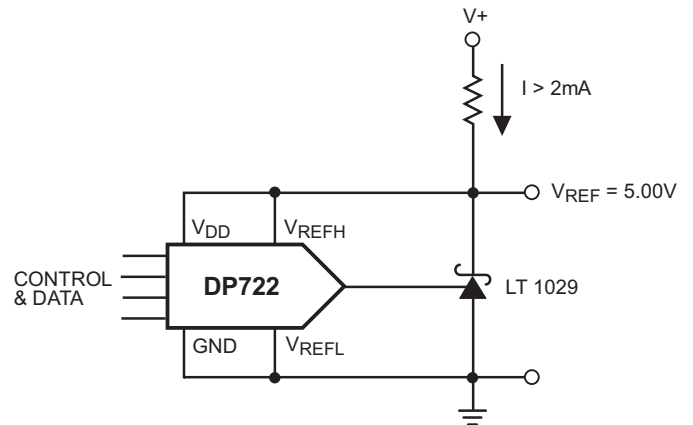


DP INPUT		DP OUTPUT	ANALOG OUTPUT
MSB	LSB	$V_{DP} = \frac{\text{CODE}}{255} V_{FS} - V_{ZERO} + V_{ZERO}$	
		$V_{FS} = 0.99V_{REF}$	$V_{REF} = 5V$
		$V_{ZERO} = 0.01V_{REF}$	$R_1 = R_F$
1111	1111	$\frac{255}{255} \times 0.98V_{REF} + 0.01V_{REF} = 0.990V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255} \times 0.98V_{REF} + 0.01V_{REF} = 0.502V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255} \times 0.98V_{REF} + 0.01V_{REF} = 0.498V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255} \times 0.98V_{REF} + 0.01V_{REF} = 0.014V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255} \times 0.98V_{REF} + 0.01V_{REF} = 0.010V_{REF}$	$V_{OUT} = -4.90V$

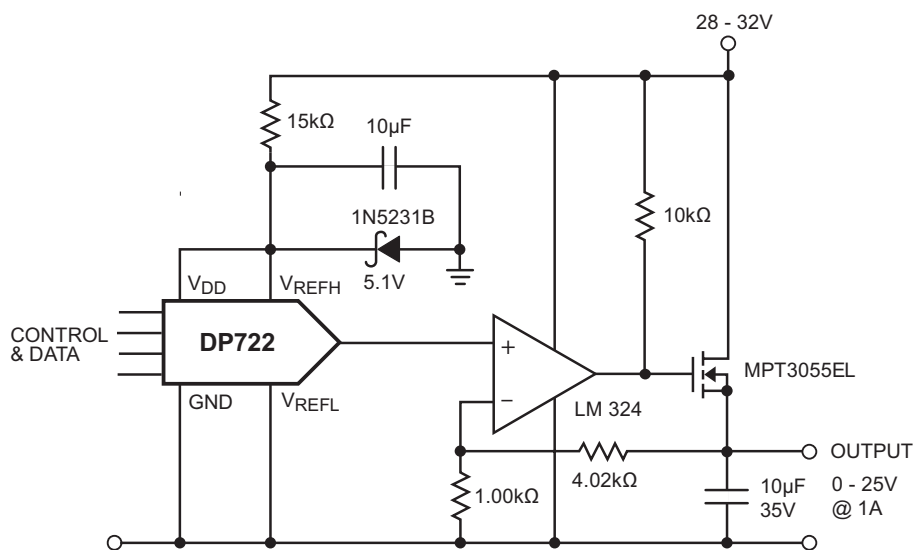
Bipolar DP Output



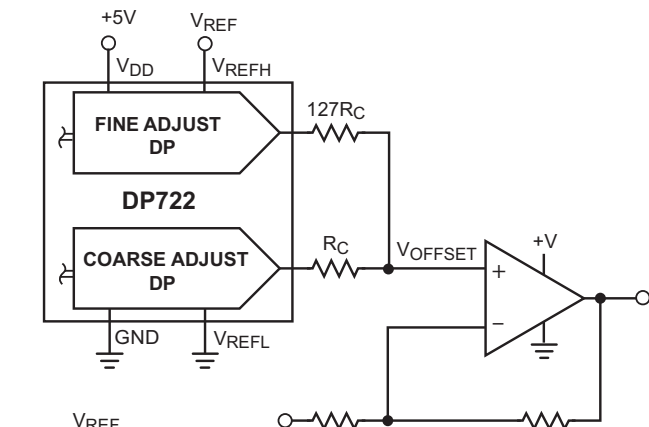
Amplified DP Output



Digitally Trimmed Voltage Reference



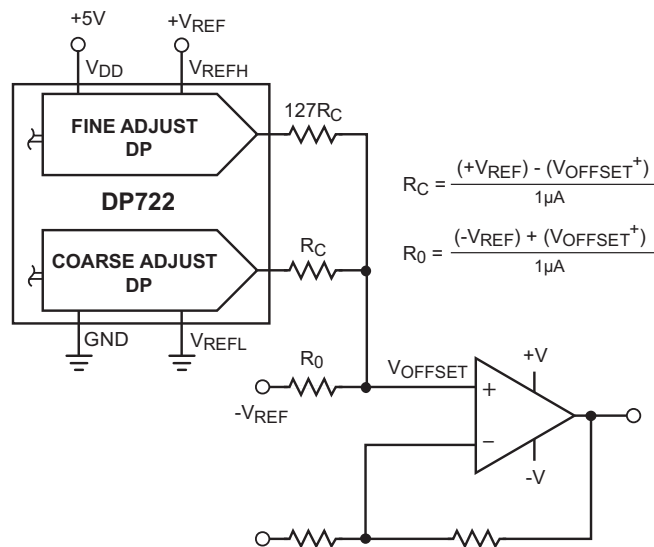
Digitally Controlled Voltage Reference



$$R_C = \frac{V_{REF}}{256 \times 1\mu A}$$

Fine adjust gives ± 1 LSB change in V_{OFFSET}

when $V_{OFFSET} = V_{REF}/2$

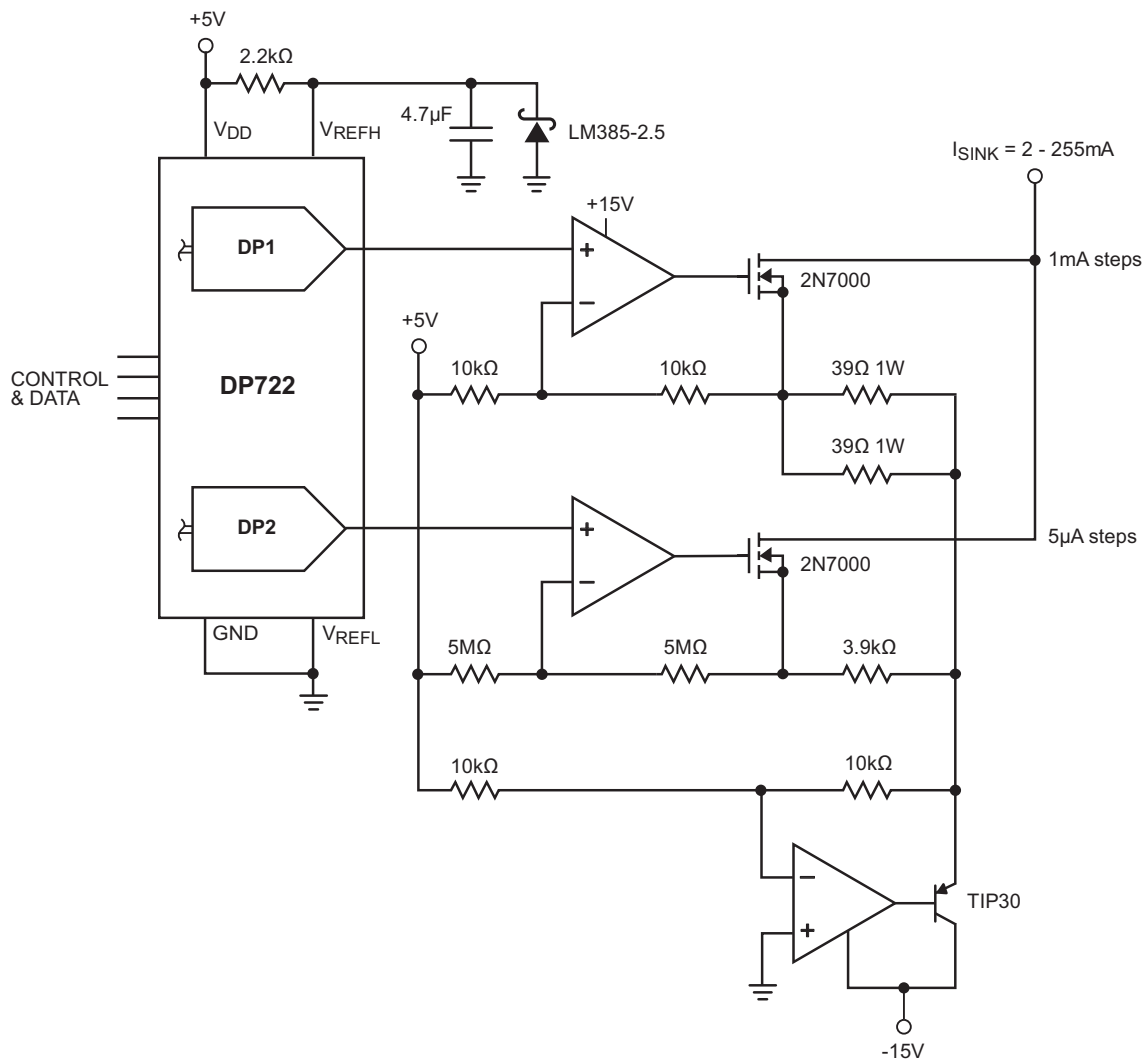


$$R_C = \frac{(+V_{REF}) - (V_{OFFSET}^+)}{1\mu A}$$

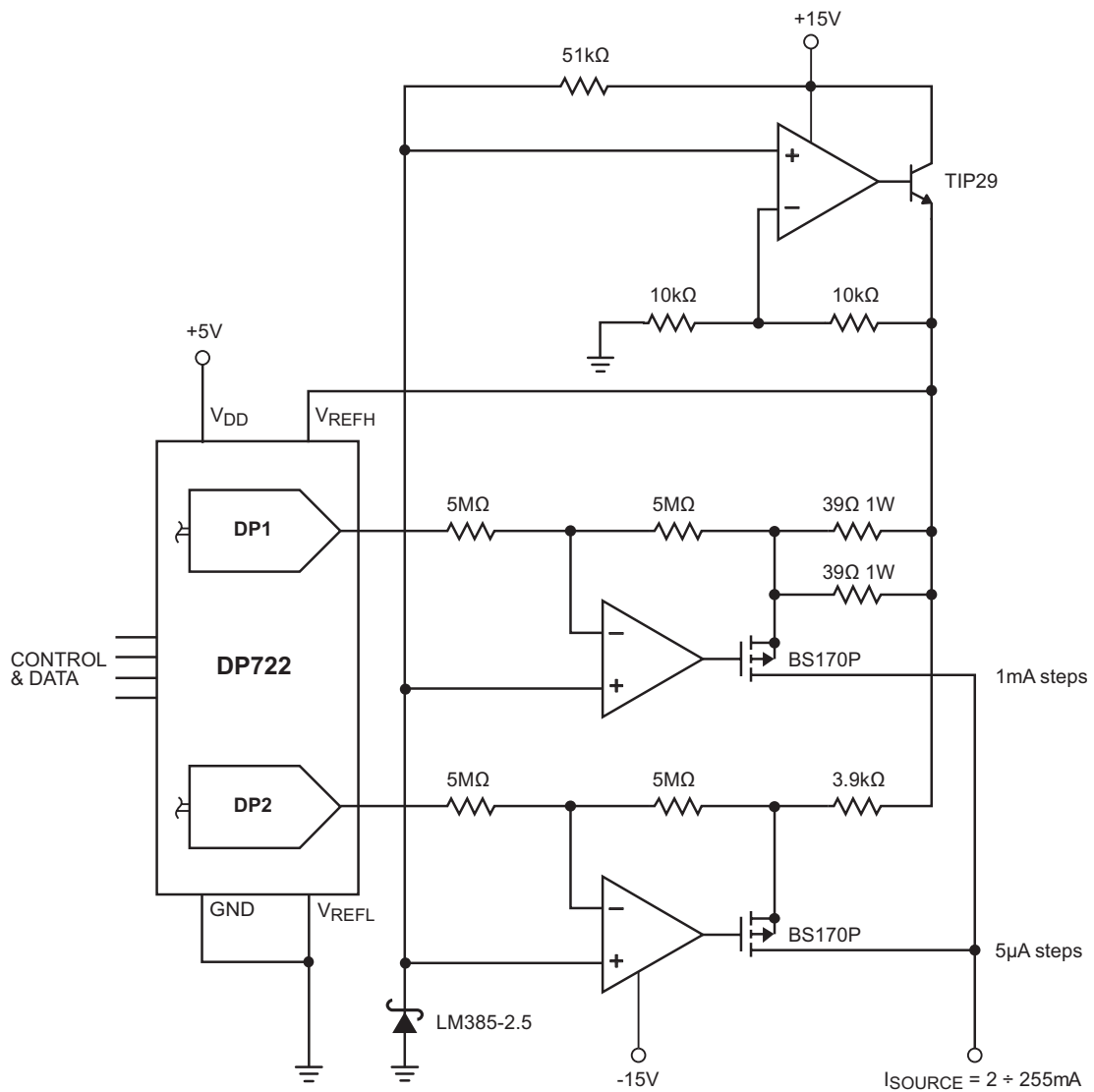
$$R_0 = \frac{(-V_{REF}) + (V_{OFFSET}^+)}{1\mu A}$$

Coarse-Fine Offset Control by Averaging DP Outputs for Single Power Supply Systems

Coarse-Fine Offset Control by Averaging DP Outputs for Dual Power Supply Systems



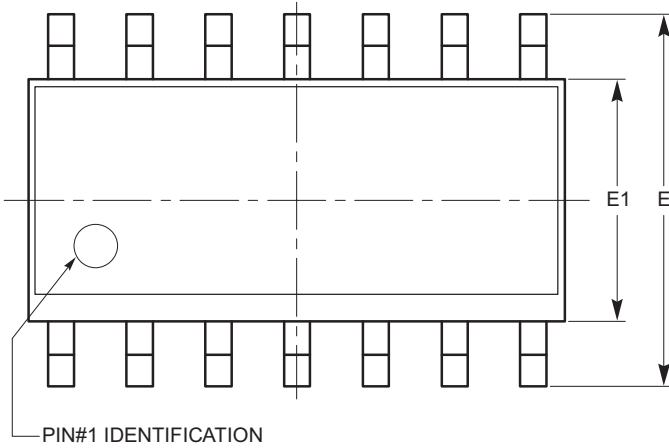
Current Sink with 4 Decades of Resolution



Current Source with 4 Decades of Resolution

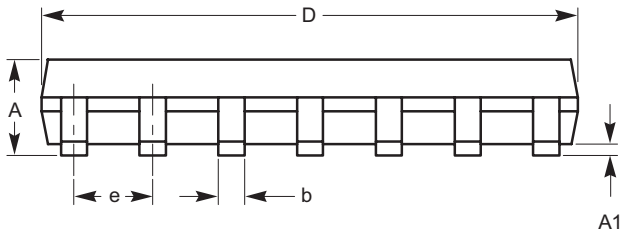
PACKAGE OUTLINE DRAWING

SOIC 14-Lead (W)⁽¹⁾⁽²⁾

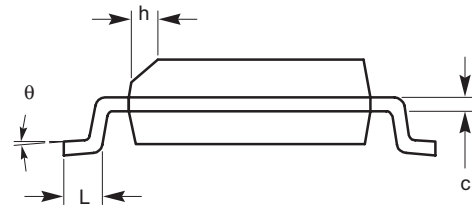


TOP VIEW

SYMBOL	MIN	NOM	MAX
A	1.35		1.75
A1	0.10		0.25
b	0.33		0.51
c	0.19		0.25
D	8.55	8.65	8.75
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27 BSC		
h	0.25		0.50
L	0.40		1.27
θ	0°		8°



SIDE VIEW

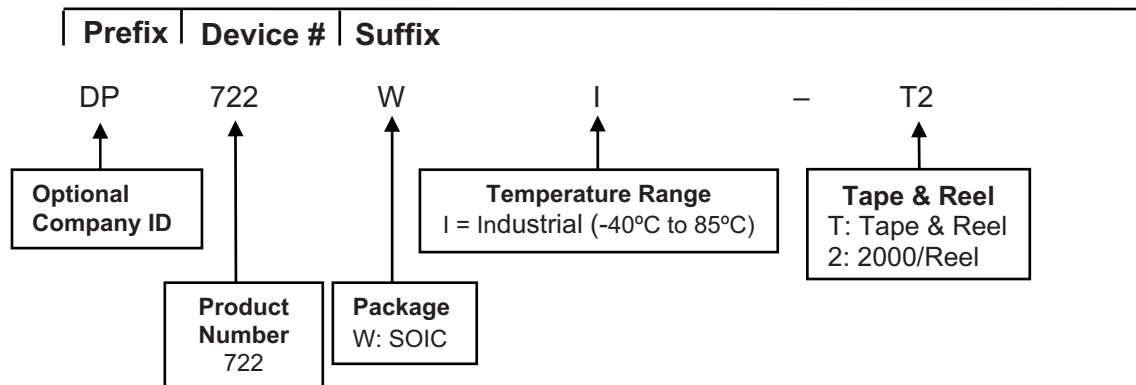


END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-012.

EXAMPLE OF ORDERING INFORMATION



ORDERING PART NUMBER
DP722WI

Notes:

- (1) All packages are RoHS compliant (Lead-free, Halogen-free).
- (2) This device used in the above example is a DP722WI-T2 (SOIC, Industrial Temperature, Tape & Reel)

REVISION HISTORY

Date	Rev.	Reason
3/16/2004	D	Updated Potentiometer Characteristics
7/12/2004	E	Updated Functional Diagram Updated Potentiometer Characteristics
07/26/2007	F	Add Package Outline Drawings Update Example of Ordering Information Updated Ordering Information Added MD- to document number
10/31/2007	G	Update Example of Ordering Information

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